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APPLICANT: L. Pierre deRochemont et al.

EXAMINER: ~~EDD~~ Donghai Nguyen

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* These patents are representative of the state of the art but published after or less than one year prior to Applicant's priority date. Therefore, if any such item is considered sufficiently relevant by the Examiner to the present invention, its possible "prior art" status against the present invention should be considered individually allowing for the prospect of swearing back or other priority determination.

**These references were disclosed in prior Patent Application No. 09/344,682, filed June 25, 1999, now U.S. Patent No. 6,323,549, and, as such, copies thereof are not included pursuant to the provisions of 37 CFR 1.98(d).

EXAMINER

D. J. H. J. J. J.

DATE CONSIDERED

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